

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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Complementary Silicon Plastic Power Transistors

Specifically designed for power audio output, or high power drivers in audio amplifiers.

- DC Current Gain Specified up to 8.0 A at Temperature
- All On Characteristics at Temperature
- High SOA: 20 A, 18 V, 100 ms
- TO-247AE Package
- Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	MJW21191 MJW21192	Unit
Collector-Emitter Voltage	V _{CEO}	150	Vdc
Collector-Base Voltage	V_{CB}	150	Vdc
Emitter-Base Voltage	V _{EB}	5.0	Vdc
Collector Current - Continuous - Peak	I _C	8.0 16	Adc
Base Current	Ι _Β	2.0	Adc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D	125 0.65	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	−65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	50	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

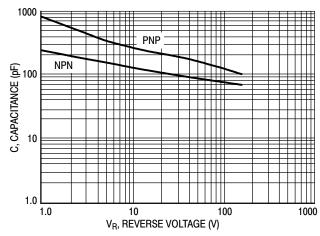


Figure 1. Typical Capacitance @ 25°C



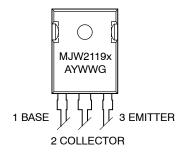
ON Semiconductor®

http://onsemi.com

8.0 A POWER TRANSISTORS COMPLEMENTARY SILICON 150 V, 125 W



MARKING DIAGRAM



= 1 or 2

= Assembly Location

/ = Year

WW = Work Week

G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
MJW21191	TO-247	30 Units/Rail
MJW21191G	TO-247 (Pb-Free)	30 Units/Rail
MJW21192	TO-247	30 Units/Rail
MJW21192G	TO-247 (Pb-Free)	30 Units/Rail

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS	_	•		
Collector–Emitter Sustaining Voltage (Note 1) $(I_C = 10 \text{ mAdc}, I_B = 0)$	V _{CEO(sus)}	150	_	Vdc
Collector Cutoff Current (V _{CB} = 250 Vdc, I _E = 0)	I _{CES}	-	10	μAdc
Emitter Cutoff Current (V _{BE} = 5.0 Vdc, I _C = 0)	I _{EBO}	_	10	μAdc
ON CHARACTERISTICS (Note 1)				
DC Current Gain ($I_C = 4.0$ Adc, $V_{CE} = 2.0$ Vdc) ($I_C = 8.0$ Adc, $V_{CE} = 2.0$ Vdc)	h _{FE}	15 5.0	100	-
Collector–Emitter Saturation Voltage ($I_C = 4.0$ Adc, $I_B = 0.4$ Adc) ($I_C = 8.0$ Adc, $I_B = 1.6$ Adc)	V _{CE(sat)}	- -	1.0 2.0	Vdc
Base–Emitter On Voltage ($I_C = 4.0 \text{ Adc}$, $V_{CE} = 2.0 \text{ Vdc}$)	V _{BE(on)}	_	2.0	Vdc
DYNAMIC CHARACTERISTICS	_	-	-	
Current Gain – Bandwidth Product (Note 2) (I _C = 1.0 Adc, V _{CE} = 10 Vdc, f _{test} = 1.0 MHz)	f⊤	4.0	_	MHz

^{1.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

^{2.} $f_T = |h_{fe}| \cdot f_{test}$

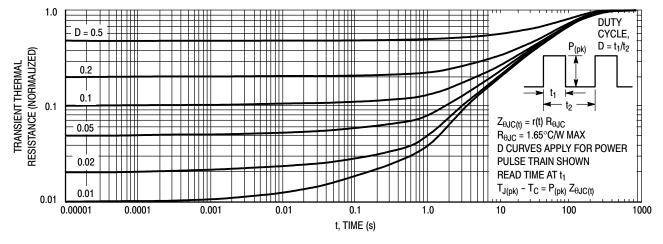


Figure 2. Thermal Response

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C – V_{CE} limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation then the curves indicate.

The data of Figures 3 and 4 is based on $T_{J(pk)} = 150^{\circ} C$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} < 150^{\circ} C$. $T_{J(pk)}$ may be calculated from the data in Figure 2. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

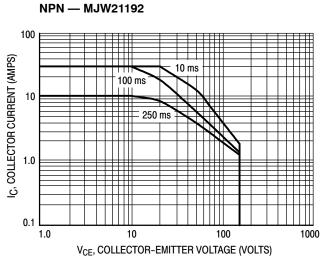


Figure 3. NPN — MJW21192 Safe Operating Area

PNP — MJW21191

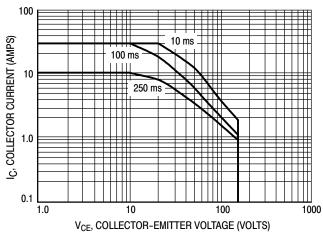
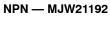


Figure 4. PNP — MJW21191 Safe Operating Area

TYPICAL CHARACTERISTICS



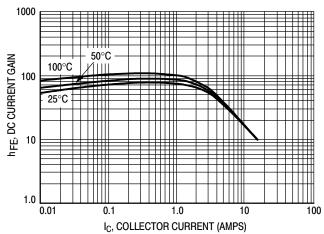


Figure 5. NPN — MJW21192 V_{CE} = 2.0 V DC Current Gain

PNP — MJW21191

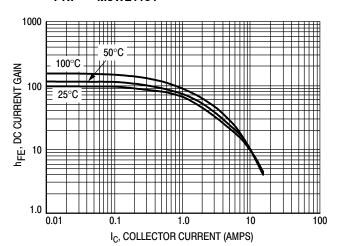
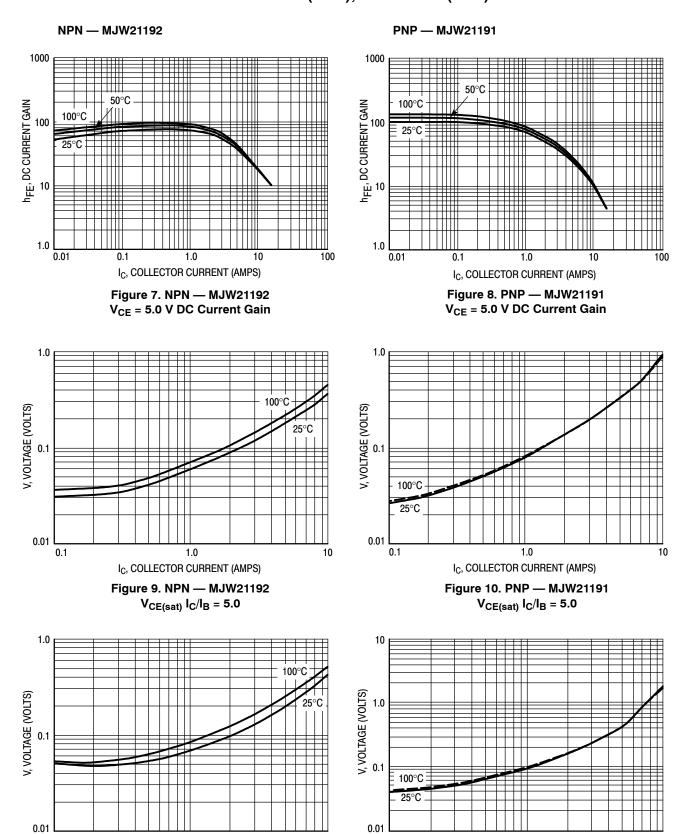


Figure 6. PNP — MJW21191 V_{CE} = 2.0 V DC Current Gain



10

0.1

1.0

I_C, COLLECTOR CURRENT (AMPS)

Figure 12. PNP — MJW21191

 $V_{CE(sat)} I_C/I_B = 10$

10

0.1

1.0

IC, COLLECTOR CURRENT (AMPS)

Figure 11. NPN — MJW21192

 $V_{CE(sat)} I_C/I_B = 10$

NPN — MJW21192

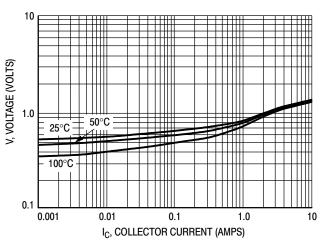


Figure 13. NPN — MJW21192 V_{CE} = 2.0 V V_{BE(on)} Curve

PNP — MJW21191

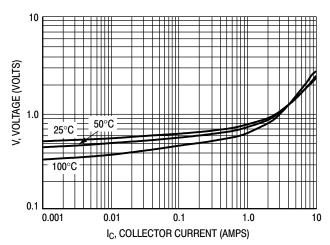
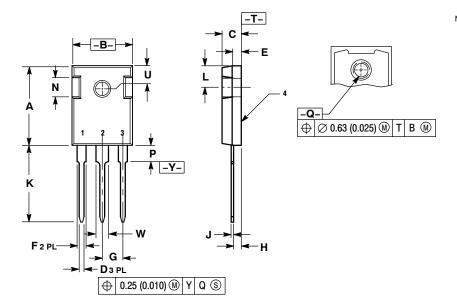


Figure 14. PNP — MJW21191 V_{CE} = 2.0 V V_{BE(on)} Curve

PACKAGE DIMENSIONS

TO-247 CASE 340L-02 **ISSUE E**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	20.32	21.08	0.800	8.30
В	15.75	16.26	0.620	0.640
O	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
Е	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
Н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
K	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Ø	3.55	3.65	0.140	0.144
U	6.15	6.15 BSC 0.242 BSC		BSC
W	2.87	3.12	0.113	0.123

STYLE 3:

PIN 1. BASE 2. COLLI

- 2. COLLECTOR 3. EMITTER
- 4. COLLECTOR

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